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April 1st, 2010 Renesas Electronics Corporation

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R1RW0404D Series

4M High Speed SRAM (1-Mword × 4-bit)

REJ03C0115-0100Z Rev. 1.00 Mar.12.2004

Description

The R1RW0404D is a 4-Mbit high speed static RAM organized 1-Mword \times 4-bit. It has realized high speed access time by employing CMOS process (6-transistor memory cell) and high speed circuit designing technology. It is most appropriate for the application which requires high speed and high density memory, such as cache and buffer memory in system. The R1RW0404D is packaged in 400-mil 32-pin SOJ for high density surface mounting.

Features

• Single supply: $3.3 \text{ V} \pm 0.3 \text{ V}$

• Access time: 12 ns (max)

• Completely static memory

— No clock or timing strobe required

• Equal access and cycle times

• Directly TTL compatible

— All inputs and outputs

• Operating current: 100 mA (max)

• TTL standby current: 40 mA (max)

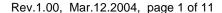
• CMOS standby current: 5 mA (max)

: 0.8 mA (max) (L-version)

• Data retention current: 0.4 mA (max) (L-version)

• Data retention voltage: 2 V (min) (L-version)

Center V_{CC} and V_{SS} type pin out

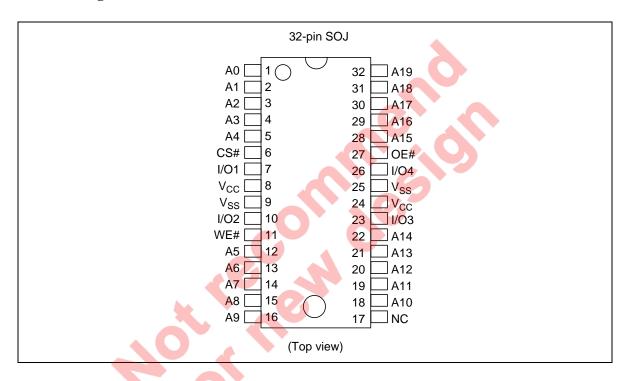




Ordering Information

Type No.	Access time	Package
R1RW0404DGE-2PR	12 ns	400-mil 32-pin plastic SOJ (32P0K)
R1RW0404DGE-2LR	12 ns	

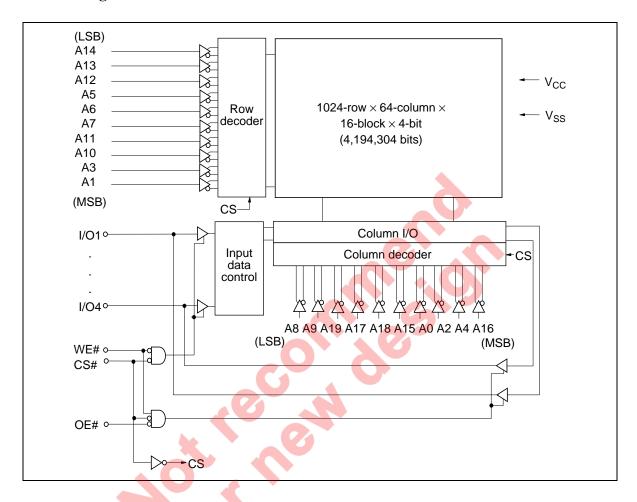
Pin Arrangement



Pin Description

Pin name	Function
A0 to A19	Address input
I/O1 to I/O4	Data input/output
CS#	Chip select
OE#	Output enable
WE#	Write enable
V _{cc}	Power supply
V _{ss}	Ground
NC	No connection

Block Diagram



Operation Table

CS#	OE#	WE#	Mode	${ m V}_{\rm cc}$ current	I/O	Ref. cycle
Н	×	×	Standby	I _{SB} , I _{SB1}	High-Z	_
L	Н	Н	Output disable	I _{cc}	High-Z	_
L	L	Н	Read	I _{cc}	D_{out}	Read cycle (1) to (3)
L	Н	L	Write	I _{cc}	D _{IN}	Write cycle (1)
L	L	L	Write	I _{cc}	D _{IN}	Write cycle (2)

Note: H: V_{IH} , L: V_{IL} , \times : V_{IH} or V_{IL}

Absolute Maximum Ratings

Parameter	Symbol	Valu e	Unit
Supply voltage relative to V _{ss}	V _{cc}	-0.5 to +4.6	V
Voltage on any pin relative to V _{ss}	V _T	-0.5^{*1} to $V_{cc} + 0.5^{*2}$	V
Power dissipation	P _T	1.0	W
Operating temperature	Topr	0 to +70	°C
Storage temperature	Tstg	-55 to +125	°C
Storage temperature under bias	Tbias	–10 to +85	°C

Notes: 1. V_{τ} (min) = -2.0 V for pulse width (under shoot) \leq 6 ns.

2. V_T (max) = V_{cc} + 2.0 V for pulse width (over shoot) \leq 6 ns.

Recommended DC Operating Conditions

 $(Ta = 0 \text{ to } +70^{\circ}C)$

Parameter	Symbol	Min	Тур	Max	Unit
Supply voltage	V _{cc} * ³	3.0	3.3	3.6	V
	V _{SS} * ⁴	0	0	0	V
Input voltage	V _{IH}	2.0	_	V _{cc} + 0.5* ²	V
	V _{IL}	$-0.5*^{1}$	_	0.8	V

Notes: 1. V_{IL} (min) = -2.0 V for pulse width (under shoot) \leq 6 ns.

- 2. V_{IH} (max) = V_{CC} + 2.0 V for pulse width (over shoot) \leq 6 ns.
- 3. The supply voltage with all $\rm V_{\rm cc}$ pins must be on the same level.
- 4. The supply voltage with all $\rm V_{\rm ss}$ pins must be on the same level.

DC Characteristics

 $(Ta = 0 \text{ to } +70^{\circ}\text{C}, \ V_{cc} = 3.3 \ V \pm 0.3 \ V, \ V_{ss} = 0 \ V)$

Parameter	Symbol	Min	Max	Unit	Test conditions
Input leakage current	II _{LI} I	_	2	μΑ	$V_{IN} = V_{SS}$ to V_{CC}
Output leakage current	II _{LO} I	_	2	μΑ	$V_{IN} = V_{SS}$ to V_{CC}
Operation power supply current	I _{cc}	_	100	mA	Min cycle $CS\# = V_{IL}, I_{OUT} = 0 \text{ mA}$ Other inputs = V_{IH}/V_{IL}
Standby power supply current	I _{SB}	_	40	mA	Min cycle, CS# = V_{IH} , Other inputs = V_{IH}/V_{IL}
	I _{SB1}	_	5	mA	
		*¹	0.8*1		
Output voltage	V_{oL}	_	0.4	V	I _{oL} = 8 mA
	V_{OH}	2.4		V	$I_{OH} = -4 \text{ mA}$

Note: 1. This characteristics is guaranteed only for L-version.

Capacitance

 $(Ta = +25^{\circ}C, f = 1.0 \text{ MHz})$

Parameter	Symbol	Min	Max	Unit	Test conditions
Input capacitance*1	C _{IN}	—	6	pF	V _{IN} = 0 V
Input/output capacitance*1	C _{I/O}	_	8	pF	V _{I/O} = 0 V

Note: 1. This parameter is sampled and not 100% tested.

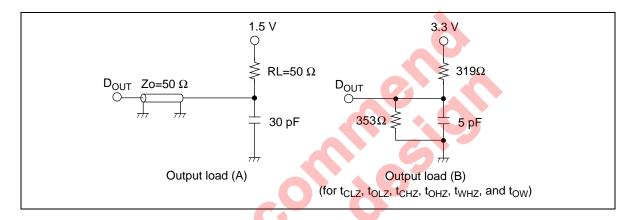
AC Characteristics

(Ta = 0 to +70°C, V_{cc} = 3.3 V \pm 0.3 V, unless otherwise noted.)

Test Conditions

Input pulse levels: 3.0 V/0.0 VInput rise and fall time: 3 ns

Input and output timing reference levels: 1.5 V
Output load: See figures (Including scope and jig)



Read Cycle

	-2			
Symbol	Min	Max	Unit	Notes
t _{RC}	12	_	ns	
t _{AA}	_	12	ns	
t _{ACS}	_	12	ns	
t _{oe}	_	6	ns	
t _{oh}	3	_	ns	
t _{CLZ}	3	_	ns	1
t _{olz}	0		ns	1
t _{CHZ}	_	6	ns	1
t _{ohz}	_	6	ns	1
	t _{RC} t _{AA} t _{ACS} t _{OE} t _{OH} t _{CLZ} t _{CLZ}	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$

R1RW0404D

Write enable to output in high-Z

Write Cycle

		R1RW0	404D			
		-2				
Parameter	Symbol	Min	Max	Unit	Notes	
Write cycle time	t _{wc}	12	_	ns		
Address valid to end of write	t _{AW}	8	_	ns		
Chip select to end of write	t _{cw}	8	_	ns	9	
Write pulse width	t _{wP}	8	_	ns	8	
Address setup time	t _{AS}	0	_	ns	6	
Write recovery time	t _{wR}	0	<u> </u>	ns	7	
Data to write time overlap	t _{DW}	6		ns		
Data hold from write time	t _{DH}	0		ns		
Write disable to output in low-Z	t _{ow}	3	Y	ns	1	
Output disable to output in high-Z	t _{ohz}		6	ns	1	

Notes: 1. Transition is measured ±200 mV from steady voltage with output load (B). This parameter is sampled and not 100% tested.

- 2. Address should be valid prior to or coincident with CS# transition low.
- 3. WE# and/or CS# must be high during address transition time.
- 4. If CS# and OE# are low during this period, I/O pins are in the output state. Then, the data input signals of opposite phase to the outputs must not be applied to them.

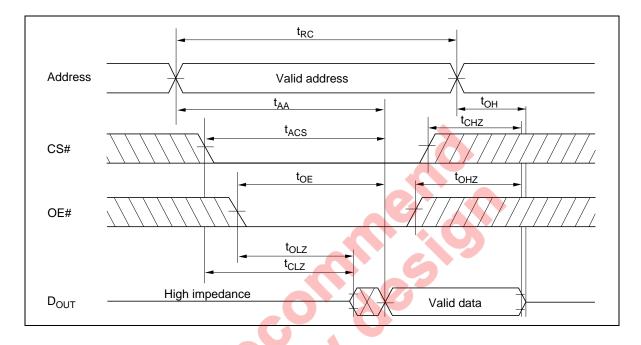
6

ns

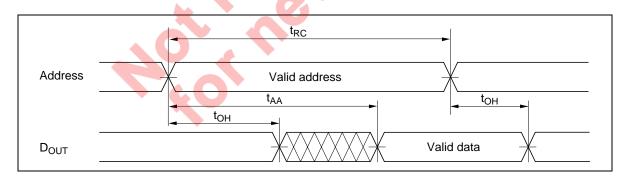
- 5. If the CS# low transition occurs simultaneously with the WE# low transition or after the WE# transition, output remains a high impedance state.
- 6. t_{as} is measured from the latest address transition to the later of CS# or WE# going low.
- 7. t_{wR} is measured from the earlier of CS# or WE# going high to the first address transition.
- 8. A write occurs during the overlap of a low CS# and a low WE#. A write begins at the latest transition among CS# going low and WE# going low. A write ends at the earliest transition among CS# going high and WE# going high. t_{wP} is measured from the beginning of write to the end of write.
- 9. t_{cw} is measured from the later of CS# going low to the end of write.

Timing Waveforms

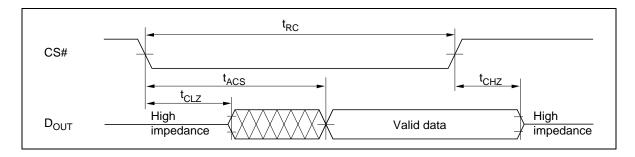
Read Timing Waveform (1) (WE# = $V_{_{IH}}$)



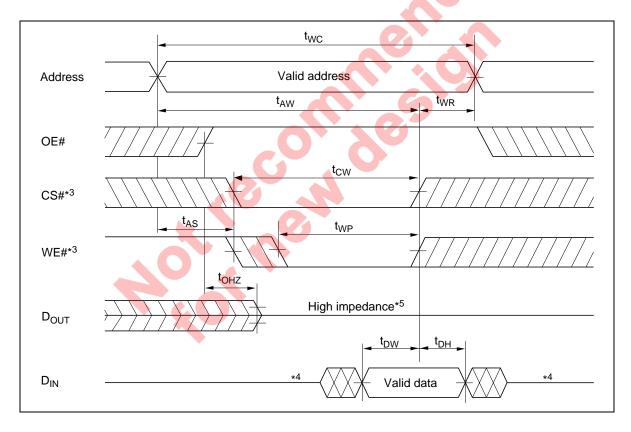
Read Timing Waveform (2) (WE# = V_{III} , CS# = V_{IL} , OE# = V_{IL})



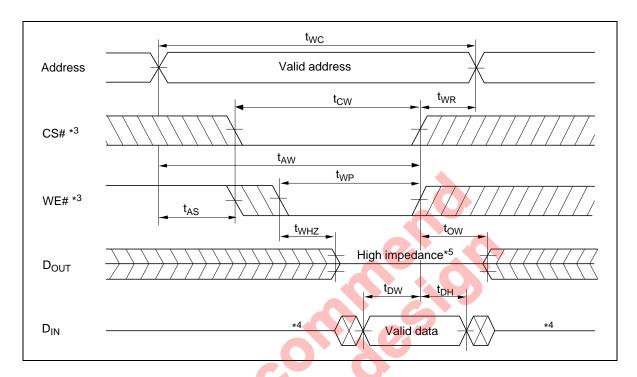
Read Timing Waveform (3) (WE# = $V_{_{I\!I}}$, CS# = $V_{_{I\!I}}$, OE# = $V_{_{I\!I}}$)*



Write Timing Waveform (1) (WE# Controlled)



Write Timing Waveform (2) (CS# Controlled)



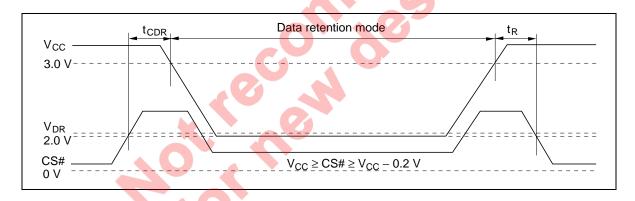
Low $V_{\rm cc}$ Data Retention Characteristics

 $(Ta = 0 \text{ to } +70^{\circ}C)$

This characteristics is guaranteed only for L-version.

Parameter	Symbol	Min	Max	Unit	Test conditions
V _{cc} for data retention	V_{DR}	2.0	_	V	$\begin{aligned} &V_{\text{cc}} \geq \text{CS\#} \geq V_{\text{cc}} - 0.2 \text{ V} \\ &(1) & 0 \text{ V} \leq V_{\text{IN}} \leq 0.2 \text{ V or} \\ &(2) & V_{\text{cc}} \geq V_{\text{IN}} \geq V_{\text{cc}} - 0.2 \text{ V} \end{aligned}$
Data retention current	CCDR	_	400	μА	$V_{cc} = 3 \text{ V}, V_{cc} \ge \text{CS\#} \ge V_{cc} - 0.2 \text{ V}$ (1) $0 \text{ V} \le V_{IN} \le 0.2 \text{ V or}$ (2) $V_{cc} \ge V_{IN} \ge V_{cc} - 0.2 \text{ V}$
Chip deselect to data retention time	t _{CDR}	0	_	ns	See retention waveform
Operation recovery time	t _R	5	_	ms	

Low \boldsymbol{V}_{cc} Data Retention Timing Waveform



Revision History

R1RW0404D Series Data Sheet

Rev.	Date	Conte	Contents of Modification		
		Page	Description		
0.01	Oct. 01, 2003	_	Initial issue		
1.00	Mar.12.2004	_	Deletion of Preliminary		



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